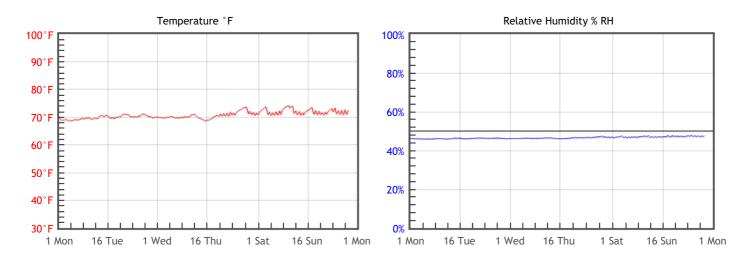
3RBR_YIVO

CJH • Library_Services • Rare_Materials • YIVO_Strashun Center for Jewish History

Preservation Environment Evaluation

Type of Decay	Risks & Metrics	Evaluation & General Comments				
Natural Aging Chemical decay of organic materials	RISK TWPI = 39	Accelerated rate of chemical decay in all organic materials due to the cumulative effects of temperature and humidity, with especially high risk f fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics.				
Mechanical Damage Physical damage to hygroscopic materials	GOOD % DC = 0.05 % EMC min = 8.6 % EMC max = 8.7	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.				
Mold Risk Mold growth in area or on collection objects	GOOD MRF = 0	Minimal risk of mold growth.				
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 8.7	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.				

Graphs



Statistics

Temperature		Relative Humidity		Dew Poi	Dew Point		T Limits		%RH Limits	
T°F Mean	70.8	%RH Mean	46	DP°F Mean	49.3	T°F < 2	0%	%RH < 50	100%	
T°F Median	70.6	%RH Median	46	DP°F Median	49.1	T°F > 2	100%	%RH > 50	0%	
T°F Stdev	1.3	%RH Stdev	1	DP°F Stdev	1.4					
T°F Min	68.5	%RH Min	46	DP°F Min	46.8					
T°F Max	74.1	%RH Max	56	DP°F Max	54.6					
		7333337	- •							